

#### **General Description**

The SJH40NP430 uses advanced trench technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

#### Features

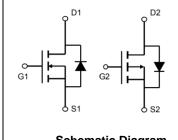
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

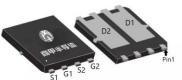
#### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

#### **Key Performance Parametes**

Parameter	Value	Value	Unit
V <sub>DS</sub>	40	-40	V
R <sub>DS(ON)_TYP</sub>	9.7	24.3	mΩ
ID	34	-21	А
Q <sub>G</sub>	24.5	60	nC







Schematic Diagram

#### PDFN5X6 top&bottom view

#### **Package Marking and Ordering Information**

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJH40NP430	SJH40NP430	PDFN5X6	Tape	١	١	2500 Pcs

#### Table 1. Absolute Maximum Ratings (T<sub>c</sub>=25℃ unless otherwise noted)

Symbol	Parameter	N Limit	P Limit	Unit
V <sub>DS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0V)	40	-40	V
V <sub>GS</sub>	Gate-Source Voltage (V <sub>DS</sub> =0V)	±20	±20	V
1-	Drain Current-Continuous(Tc=25°C)	34	-21	A
ID	Drain Current-Continuous(T <sub>C</sub> =100℃)		-13	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	136	-84	A
D	Maximum Power Dissipation(Tc=25°C)	25	23	W
PD	Maximum Power Dissipation(Tc=100°C)		9.3	W
E <sub>AS</sub>	Avalanche energy (Note 2)	64	56	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150 °C		Ĉ

#### Table 2. Thermal Characteristic

Symbol	Parameter	N Limit	P Limit	Unit
$R_{ heta JA}$	Thermal Resistance, Junction-to- Case		5.4	°C/W



### Table 3. N-Channel Electrical Characteristics (TJ=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	40			V
		V <sub>DS</sub> =40V, V <sub>GS</sub> =0V TJ=25℃			1	μA
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V TJ=125℃			100	μA
lgss	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	1		2	V
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =15A		20		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =15A T <sub>J</sub> =25℃		9.7	12.6	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A T <sub>J</sub> =25℃		13.3	17.7	mΩ
Dynamic Chara	cteristics					
Ciss	Input Capacitance			1160		pF
Coss	Output Capacitance	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V, f=1.0MHz		84		pF
Crss	Reverse Transfer Capacitance			70		pF
Rg	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		1.6		Ω
Switching Para	meters					
t <sub>d(on)</sub>	Turn-on Delay Time			4.6		nS
tr	Turn-on Rise Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =20V,		12		nS
$t_{d(off)}$	Turn-Off Delay Time	$R_{L}=1.3\Omega, R_{GEN}=3\Omega$		18.8		nS
t <sub>f</sub>	Turn-Off Fall Time			6		nS
Qg	Total Gate Charge			24.5		nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =15A		3.7		nC
$Q_gd$	Gate-Drain Charge			6.3		nC
Source-Drain D	iode Characteristics		•	·		·
I <sub>SD</sub>	Source-Drain Current (Body Diode)				34	А
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =15A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	l⊧=15A, dl/dt=100A/μs		17.5		ns
Qrr	Reverse Recovery Charge	I⊧=15A, dI/dt=100A/µs		10.9		nC

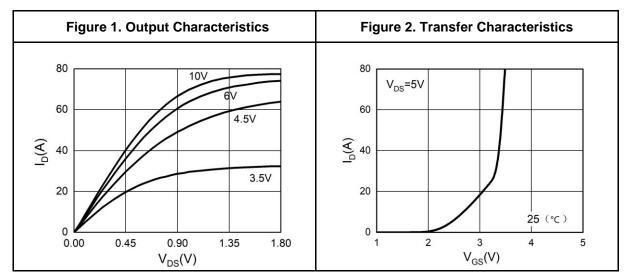
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

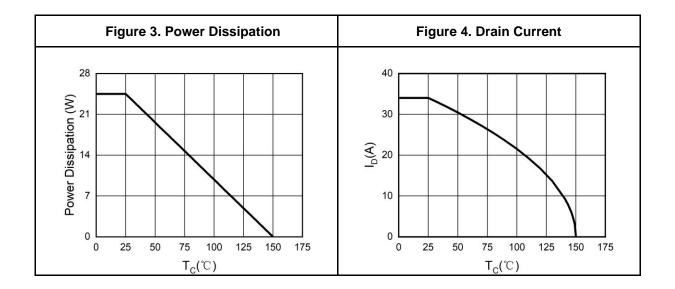
Notes 2.E<sub>AS</sub> condition:  $T_J=25^{\circ}C$ ,  $V_{DD}=30V$ ,  $V_G=10V$ ,  $Rg=25\Omega$ , L=0.5mH.

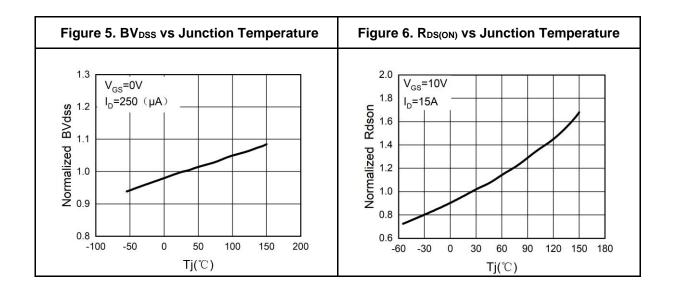
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### N-Channel Typical Electrical And Thermal Characteristics (Curves)

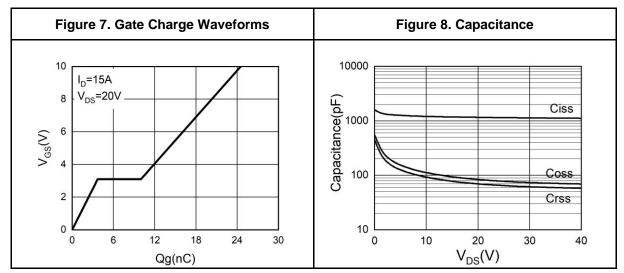


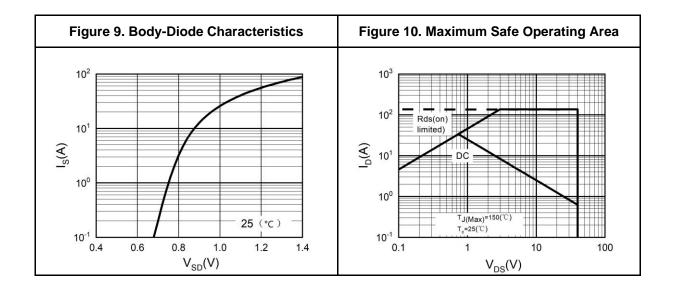






### N-Channel Typical Electrical And Thermal Characteristics (Curves)







### Table 4. P-Channel Electrical Characteristics (TJ=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States	·					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-40			V
		V <sub>DS</sub> =-40V, V <sub>GS</sub> =0V TJ=25℃			-1	μA
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-40V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			-100	μA
lgss	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250µA	-1		-2.5	V
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-3A		7		S
RDS(ON)	Drain-Source On-State Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-3A T <sub>J</sub> =25℃		24.3	31.6	mΩ
RDS(ON)	Drain-Source On-State Resistance	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-2A T <sub>J</sub> =25℃		31.2	41.5	mΩ
Dynamic Chara	cteristics		•			
Ciss	Input Capacitance			1010		pF
Coss	Output Capacitance	V <sub>DS</sub> =-20V,V <sub>GS</sub> =0V, f=1.0MHz		96		pF
Crss	Reverse Transfer Capacitance			83		pF
Rg	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		5.1		Ω
Switching Para	meters		•			
t <sub>d(on)</sub>	Turn-on Delay Time			10		nS
tr	Turn-on Rise Time	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V,		15		nS
t <sub>d(off)</sub>	Turn-Off Delay Time	$R_{L}=6.7\Omega, R_{GEN}=3\Omega$		38		nS
t <sub>f</sub>	Turn-Off Fall Time			16.4		nS
Qg	Total Gate Charge			60		nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, I <sub>D</sub> =-3A		8.5		nC
$Q_gd$	Gate-Drain Charge			13		nC
Source-Drain D	iode Characteristics		•			
I <sub>SD</sub>	Source-Drain Current (Body Diode)				-21	Α
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =-3A			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	l⊧=-3A, dl/dt=-100A/μs		17.3		ns
Qrr	Reverse Recovery Charge	I⊧=-3A, dI/dt=-100A/μs		9.5		nC

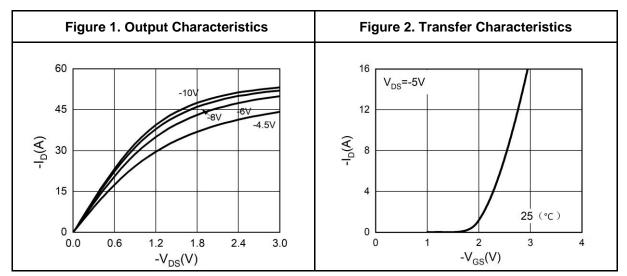
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

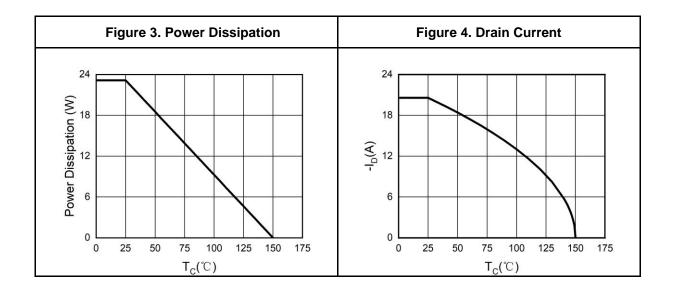
Notes 2.E<sub>AS</sub> condition: T<sub>J</sub>=25°C,V<sub>DD</sub>=-40V,V<sub>G</sub>=-10V, Rg=25Ω, L=0.5mH.

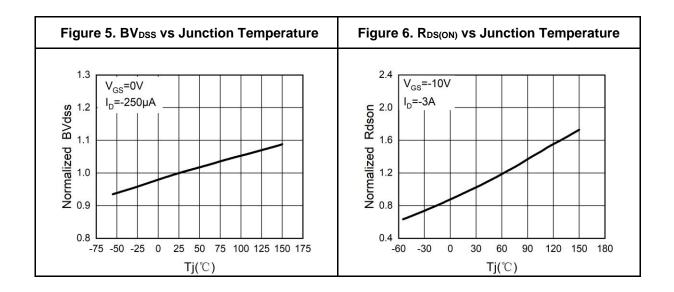
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### P-Channel Typical Electrical And Thermal Characteristics (Curves)

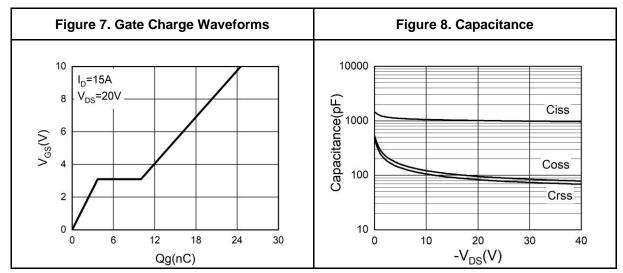


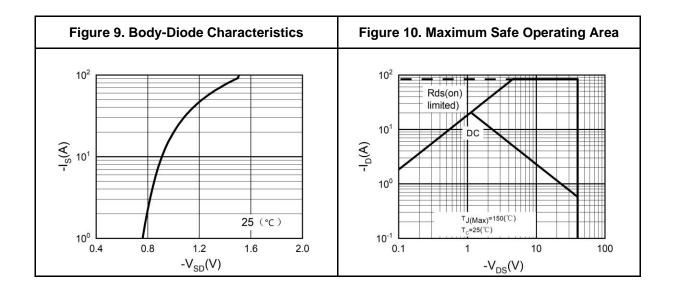






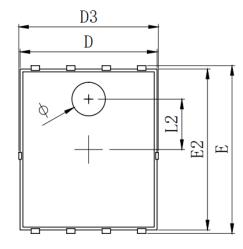
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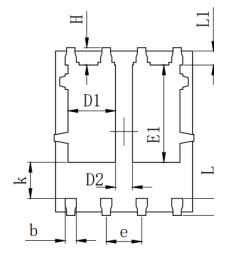




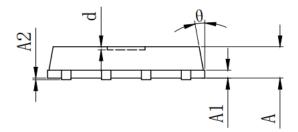


## PDFN5X6-8L Package Information





SYMBOL	MILLIMETER				
SIMBUL	MIN	Тур.	MAX		
А	0.900	1.000	1.100		
A1		0.254 REF.			
A2		0 <sup>~</sup> 0. 05			
D	4.824	4.900	4.976		
D1	1.605	1.705	1.805		
D2	0.500	0.600	0.700		
D3	4.924	5.000	5.076		
E	5.924	6.000	6.076		
E1	3.375	3.475	3. 575		
E2	5.674	5.750	5.826		
b	0.350	0.400	0.450		
е	1.270 TYP.				
L	0.534	0.610	0.686		
L1	0.424	0.500	0.576		
L2		1.800 REF.			
k	1.190	1.290	1.390		
Н	0.549	0.625	0.701		
θ	8°	10°	12°		
φ	1.100	1.200	1.300		
d			0.100		





### Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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